#### N-Channel 100V, 18mΩ Typ. Power MOSFET

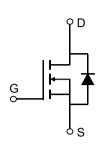
#### **Description**

#### **Features**

• 100V, 40A

 $R_{DS(ON)}$  Typ =  $18m\Omega$  @  $V_{GS}$  = 10V

- Advanced Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

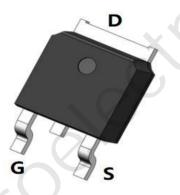


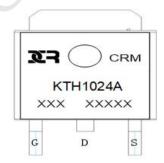


# Schematic Diagram

# **Application**

- Load Switch
- PWM Application
- Power Management





**Marking and Pin Assignment** 

#### **Package Marking and Ordering Information**

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKTH1024A	CRMKTH1024A	TO-252-3L	TAPING	13"	2500	25000

#### Absolute Maximum Ratings (@ T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
$V_{DS}$	Drain-to-Source Voltage		100	V
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V
Ι <sub>D</sub>	Continuous Drain Current	T <sub>C</sub> = 25°C	40	А
		T <sub>C</sub> = 100°C	24	Α
I <sub>DM</sub>	Pulsed Drain Current (1)		160	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy <sup>(2)</sup>		144	mJ
$P_{D}$	Power Dissipation	T <sub>C</sub> = 25°C	105	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		1.19	°C/W
$T_J, T_STG$	Junction & Storage Temperature Range		-55 to 150	°C

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#### **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V	-	-	1.0	μΑ
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	2.9	4	V
R <sub>DS(ON)</sub>	Static Drain-Source ON-Resistance <sup>(3)</sup>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A	-	18	24	mΩ
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance		- /	3815	-	pF
$C_{oss}$	Output Capacitance	$V_{GS} = 0V, V_{DS} = 25V,$ f = 1MHz	-	197	-	pF
$C_{rss}$	Reverse Transfer Capacitance	I - IIVINZ	X -	155	-	pF
Q <sub>g</sub>	Total Gate Charge	(	-	78	-	nC
$Q_gs$	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 50V, I_{D} = 20A$	<b>U</b> .	20	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	V <sub>DS</sub> - 30 V, I <sub>D</sub> - 20A	-	22	-	nC
Switchin	g Characteristics					
t <sub>d(on)</sub>	Turn-On DelayTime		-	17	-	ns
$t_r$	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 50V$	-	27	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D$ = 20A, $R_{GEN}$ = $6\Omega$	-	45	-	ns
$t_f$	Turn-Off Fall Time		-	10	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current		-	-	40	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	160	Α
$V_{SD}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 45A - 4:1/4 - 400A1	-	44	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 15A$ , di/dt = 100A/us	-	72	-	nC

Notes:

<sup>1.</sup> Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

<sup>2.</sup>  $E_{AS}$  condition: Starting  $T_J$ =25°C,  $V_{DD}$ =30V,  $V_G$ =10V,  $R_G$ =25ohm, L=0.5mH,  $I_{AS}$ =24A

<sup>3.</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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# **Typical Performance Characteristics**

Figure 1: Output Characteristics 30 V<sub>GS</sub>=10V 25 V<sub>GS</sub>=5.5V 20 (<del>V</del>) 15 V<sub>GS</sub> =4.8V 10 V<sub>GS</sub> =4.5V 5 0 0 1 2 3 VDs(V)

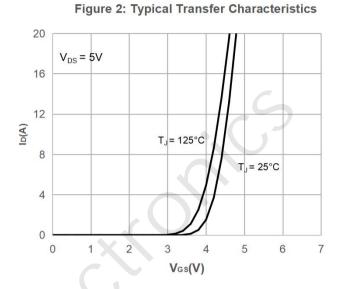


Figure 3: On-resistance vs. Drain Current

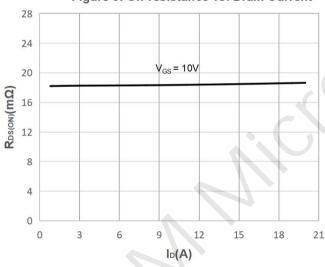


Figure 4: Body Diode Characteristics

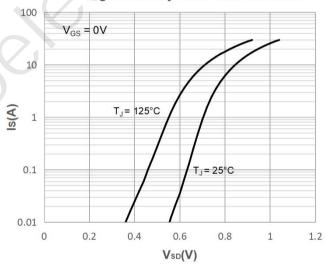


Figure 5: Gate Charge Characteristics

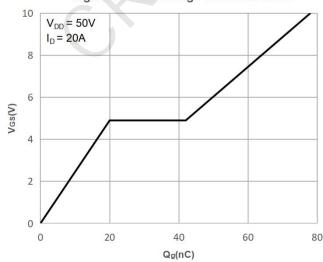
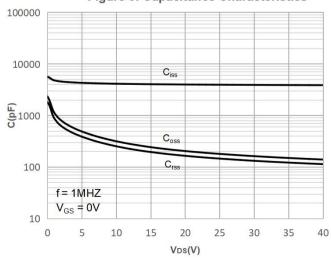


Figure 6: Capacitance Characteristics



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# **Typical Performance Characteristics**

Figure 7: Normalized Breakdown voltage vs.
Junction Temperature

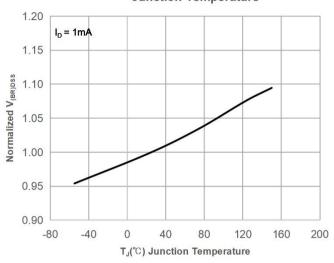


Figure 9: Maximum Safe Operating Area

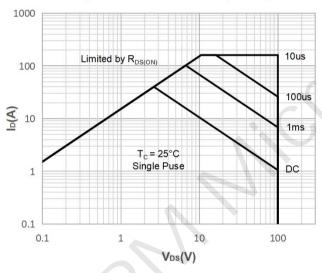


Figure 11: Normalized Maximum Transient

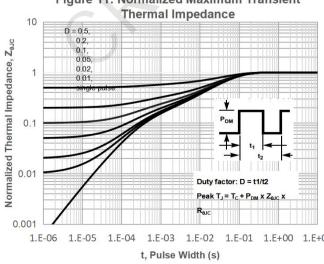


Figure 8: Normalized on Resistance vs. Junction Temperature

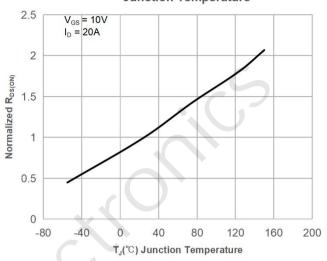


Figure 10: Maximum Continuous Drian
Current vs. Case Temperature

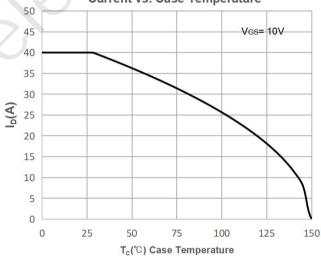
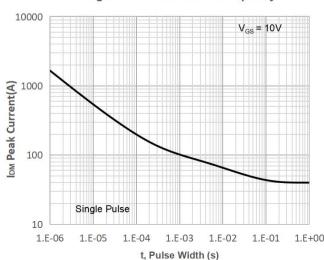


Figure 12: Peak Current Capacity



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#### **Test Circuit**

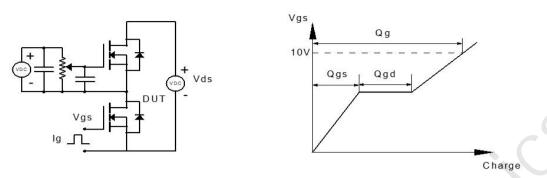


Figure 1: Gate Charge Test Circuit & Waveform

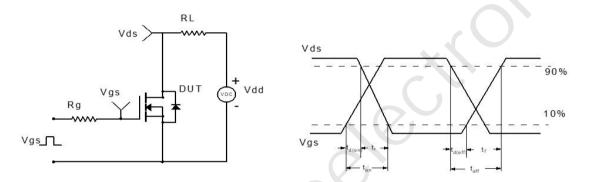


Figure 2: Resistive Switching Test Circuit & Waveform

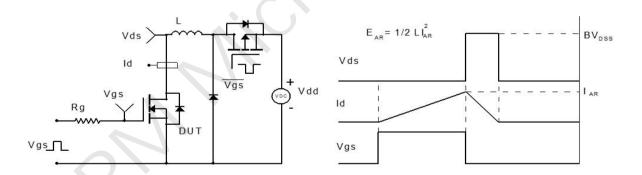


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

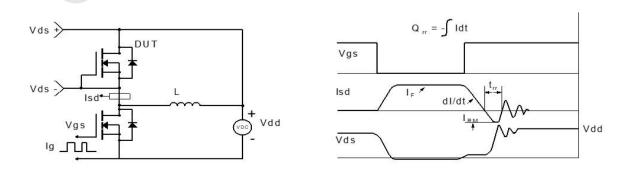
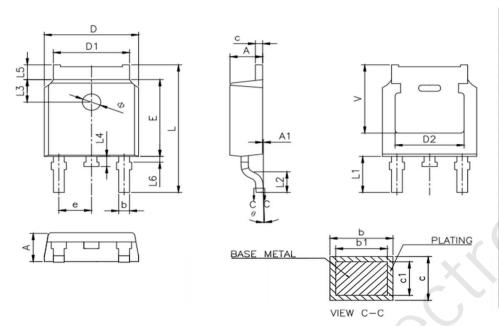


Figure 4: Diode Recovery Test Circuit & Waveform

N-Channel 100V, 18mΩ Typ. Power MOSFET

#### Package Mechanical Data(TO-252-3L)



SYMBOL	MILLIMETER				
STWIDOL	MIN NOM		MAX		
Α	2.20	2.30	2.40		
A1	0.00		0.127		
b	0.66		0.86		
b1	0.65	0.76	0.81		
D	6.50	6.60	6.70		
D1	5.10	5.33	5.46		
С	0.47		0.60		
c1	0.46	0.51	0.56		
D2	4.83 REF.				
E	6.00	6.10	6.20		
е	2.186	2.286	2.386		
L/	9.80	10.10	10.40		
L1	2.90 REF.				
L2	1.40	1.50	1.60		
L3	1.80 REF.				
L4	0.60	0.80	1.00		
L5	0.90		1.25		
L6	0.15		0.75		
Ф	1.10		1.30		
θ	0.		8*		
V	5.40 REF				

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